

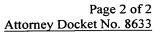
Page 1 of 2 Attorney Docket No. 8633

As a below named inventor, I hereby declare that:

My residence, mailing address	and citizenship are as stat	ed below next to my name.		
(if plural names are listed belo METHODS, FUNCTIONAL I	w) of the subject matter w	r (if only one name is listed bely hich is claimed and for which a FOR OPTIMIZING PRODUCT	a patent is sou	
the specification of which (check [] one) []	and was amended on	pplication Serial No (if applicable)		States Application No. or
as amended by any amendmen:  I acknowledge the duty for continuation-in-part applica and the national or PCT interna I hereby claim foreign inventor's certificate, or §365(a States of America, listed below	t referred to above.  to disclose information values, material informational filing date of the copriority benefits under 35 a) of any PCT International date and have also identified.	which is material to patentability on which became available between the production of the continuation of	y as defined in veen the filing of any foreig at least one corpatent or in	n 37 C.F.R. §1.56, including date of the prior application application(s) for patent or country other than the United eventor's certificate, or of any
Prior Foreign Application(s)			<u>Prior</u> []	ity Claimed []
(Number)	(Country)	(Day/Month/Year Filed)	Yes	
I hereby claim the benefit under	r Title 35, United States C	Code §119(e) of any United Stat	es provisiona	l application(s) listed below.
Application Serial No.	Filing Date	Application Serial N	o	Filing Date
application designating the Un application is not disclosed in paragraph of 35 U.S.C. §112, I	ited States of America, line the prior United States acknowledge the duty to	any United States application( sted below and, insofar as the s or PCT International applica disclose information which is a filing date of the prior applicat	ubject matter tion in the m material to pa	of each of the claims of this nanner provided by the first tentability as defined in Title
U.S. Parent Application Number	PCT Parent Number	Parent Filing (MM/DD/Y)		Parent Patent Number (If applicable)
		actitioners associated with Cusplication and transact all busing		

connected therewith.

SEND CORRESPONDENCE TO: Customer Number <u>27752</u>



I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first joint inventor SEAN MICHAEL KANE	
Inventor's signature	
	Date
Residence 1312 Windsor Harbor Drive, Jacksonville, FL 32225	
Citizenship US Mailing Address 1312 Windsor Harbor Drive, Jacksonville, FL 32225	
Walling Address 1512 Wildsof Haroof Diffe, Jackson vine, 12 52225	
•	
Full name of second joint inventor, if any TIMOTHY EUGENE MUNSON	
Inventor's signature	
inventor's signature	Date
Citizenship US	
Mailing Address 108 W. Stoneridge Drive, Milford, OH 45150	
Full name of third joint inventor, if any PETER SZEHAO HSI	·
Inventor's signature	
inventor's signature	Date
Residence 10706 Woodgate Lane, Cincinnati, OH 45242	
Citizenship US	
Mailing Address 10706 Woodgate Lane, Cincinnati, OH 45242	